Effect of Electric Current on the Inclusions in a Cu-Zn Alloy

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The effect of electric current pulse (ECP) treatment on lead inclusions in a Cu-Zn alloy was studied in present work. It was found that with the application of a critical high current density, the coarse and random distributed lead inclusions transferred into grain boundaries or defects in dispersed small particles. The reason was ascribed to the specific electric effect of electric current on the grain refinement and the reduction of the diffusive activation energy of lead inclusions. Therefore, the high current density ECP treatment might be an effective method to refine inclusions of bulk materials.

Keywords: electric current pulse, inclusions, segregation, diffusion

1. Introduction

Electric current pulse (ECP) treatment as an important instantaneous nonequilibrium processing technique has been used in materials science and engineering field for several decades. The current research fields about ECP include: electromigration,$^{1}$ electroplastic,$^{2}$ the solidification of metals and alloys,$^{3}$ and so on. Recently, studies concerning grain refinement in conventional coarse-grained materials by applying high current density ECP treatment have achieved lots of significant results.$^{4,6}$ For example, Zhou et al. have found that grains in a low carbon steel are refined after high current density ECP treatment;$^{6}$ Zhang et al. have found that nanophases are formed in a conventional coarse-grained polycrystalline Cu-Zn alloy by applying high current density ECP treatment.$^{5}$ It gives us an insight into whether the application of ECP treatment could refine the inclusions and make them homogeneously distribute. If it is possible, the mechanical properties of metallic materials might be greatly improved.

As known, the flow of electric current can give rise to mass transport and the segregation is closed with the diffusion of atoms.$^{1}$ Moreover, Zhou et al. have proposed that the diffusion of atoms,$^{6}$ and the diffusive transformation could be accelerated properly due to the enhancement of diffusion coefficient under ECP treatment. However, though chemical segregation caused by conventional heat treatments has been studied for several years,$^{7-9}$ there are few reports about the segregation under high current density ECP treatment in bulk materials.

In present work, the effect of different current density ECP treatment on the distribution of lead inclusions in a Cu-Zn alloy was investigated, and based on thermodynamic analysis, a possible segregation mechanism of lead inclusions under ECP was proposed.

2. Experimental

A commercial Cu-Zn alloy sheet with a composition of Cu 59.1 mass%, Zn 40.6 mass%, and Pb 0.3 mass% was selected as the investigated material. The sheet was cold worked in thickness from 1.5 to 1.0 mm at room temperature by rolling. By using the electrospark discharge technique, the alloy sheet was cut into a required shape (the size of the middle part was 3 mm long, 2 mm wide, and 1 mm thick, and the size of the two ends of the sample was much larger than that of the middle part). Thus, the current density of the two ends was much less than that of the middle part during current passing. The ECP treatment was performed by capacitor banks discharge under ambient conditions with current densities at 18.0 kA mm$^{-2}$, 18.6 kA mm$^{-2}$, and 19.0 kA mm$^{-2}$, respectively. Its waveform was detected to be a damped oscillation wave by a Rogowski coil and a TDS3012 digital storage oscilloscope (Tektronix Inc., Beaverton, OR). The period of ECP ($t_p$) was about 113 μs and the pulse duration ($t_d$) was about 800 μs.

The morphology of effective parts was determined by a JSM-6301F JEOL field emission scanning electron microscope (SEM). To reveal the lead distribution, backscattered electron (BSE) in the SEM was utilized.

3. Results

Figure 1 shows SEM images of samples before and after ECP treatment. Due to previous cold rolling deformation, α and β grains in the sample before ECP treatment are coarse and elongated (Fig. 1(a)). While in ECP treated samples with current densities at 18.0 kA mm$^{-2}$ and 18.6 kA mm$^{-2}$, the similar morphology, as shown in Fig. 1(b), is obtained. It can be found that the original elongated α grains are refined to lots of needle-like grains, implying that the samples undergo a phase transformation during ECP treatment.

Figure 2 presents SEM-BSE images of the distribution of lead inclusions in the samples treated under different current density. Through the determination of EDS, it is known that white dots and grey matrix are lead inclusions and Cu-Zn matrix, respectively. Moreover, the morphology of lead inclusions in the sample treated at low current density (18.0 kA mm$^{-2}$) is similar to that in the original one (Fig. 2(a)), even α grains are refined to lots of needle-like grains (Fig. 2(b)). Fortunately, as shown in Fig. 2(c), the coarse and random distributed lead inclusions transferred into grain boundaries or defects in dispersed small particles when the sample treated under a critical current density...
(18.6 kA·mm⁻²). However, when the current density slightly higher than the critical one, the sample is melted and broken, and lead distributes along grain boundaries, as the cross section image shown in Fig. 2(d).

4. Discussion

Obviously, the temperature rise induced by Joule heat increases with the increase of current density. According to the detected waveforms of ECP, the maximum temperature rise of samples treated at 18.0 kA·mm⁻², 18.6 kA·mm⁻², and 19.0 kA·mm⁻² can be calculated as 973 K, 1023 K and 1053 K, respectively. They are over the phase transformation temperature of the Cu-Zn alloy, and as a consequent, α grains are refined to needle-like grains.

As discussed in Ref. 12), the free energy change (∆U) in Cu-Zn alloy matrix with or without inclusions has some difference due to the deformation of the current lines once a current pass through, and that with inclusions can be written as \( \Delta U = \Delta U_0 + \Delta U_e \), where \( \Delta U_0 \) is the change of free energy in a current-free system, \( \Delta U_e \) an energy change due to the change of distribution of current. On the other hand, \( \Delta U_e \) takes the following expression generally \(^\text{13-15}\)

\[
\Delta U_e = \mu g \xi V j^2
\]  

where \( \mu \) is the magnetic susceptibility equaling to that in vacuum (\( \mu_0 \)) in present work; \( g \) a geometric factor; \( V \) the volume of an inclusion, and \( j \) the current density. \( \xi \) a factor depending on the electrical conductivities of the matrix and the inclusion, \( \xi = (\sigma_{br} - \sigma_{Pb})/(\sigma_{br} + 2\sigma_{Pb}) \), where the subscripts br and Pb represent the Cu-Zn alloy and lead, respectively. From eq. (1), it is apparent that the sign of \( \Delta U_e \) is dominated only by the sign of \( \xi \). Since the maximum
temperature rise of the sample treated under the critical current density is 1023 K, and \( \sigma_{\text{liq}} \) and \( \sigma_{\text{pb}} \) at melting point of lead (600 K) are \( 6.69 \times 10^6 \, \Omega^{-1}\cdot\text{m}^{-1} \) and \( 2.15 \times 10^6 \, \Omega^{-1}\cdot\text{m}^{-1} \), respectively.\(^{16}\) It is expected that \( \sigma_{\text{liq}} > \sigma_{\text{pb}} \) at 1023 K, and \( \xi > 0 \) and then \( \Delta U_\epsilon > 0 \). That is to say, the free energy of the matrix with the lead inclusion is higher than that of the matrix without inclusion once a current passing through. Hence, the energy distribution of the system under ECP treatment can be schematically shown in Fig. 3. With the increase of current density, the free energy difference is enlarged until the lead inclusion becomes unstable at a certain critical value. Because of the rapid cooling course, the unstable solid state at such a high temperature is held to the ambient temperature.

On the other hand, by comparing the distribution of lead inclusions before and after ECP treatment, the average diffusion distance of lead in ECP duration of 800\( \mu \)s can be evaluated as half of the average distance of 5\( \mu \)m. Therefore, the average atomic drift velocity of lead is about \( 10^3 \, \mu\text{m}\cdot\text{s}^{-1} \). In general, the diffusion of atoms during ECP treatment is mainly controlled by three factors: temperature gradient, concentration gradient, and electric current effect. Hereinto, the temperature gradient between the matrix with lead inclusion and that without vanishes immediately during current passing. That’s to say, temperature gradient is not the main factor for the diffusion of atoms.

Then, concentration gradient might be the reason and the average atomic drift velocity controlled by concentration gradient can be calculated as follows:

\[
v_c = \frac{D_c \Delta X_c}{X_c \Delta x}
\]

Where \( X_c \) is the lead content in Cu-Zn alloy (0.3%); \( \Delta X_c \) is the change of molar quantity of lead (assumed as 100%); \( \Delta x \) is the diffusion distance (5\( \mu \)m); \( D_c \) is the diffusivity of lead in copper, \( D_0 = 0.862 \, \text{cm}^2 \cdot \text{s}^{-1} \). \( Q = 1.89 \pm 0.01 \, \text{eV} \). Hence, \( v_c \) in eq. (2) is only as low as \( 10^3 \, \mu\text{m}\cdot\text{s}^{-1} \), and it is far lower than \( 10^3 \, \mu\text{m}\cdot\text{s}^{-1} \) in our case. So, concentration gradient is not the reason for long-range diffusion during ECP treatment.

So, electric current effect might be the case and the average atomic drift velocity \( v_{\text{ie}} \) produced by electric current is given by\(^{1,18,19}\)

\[
v_{\text{ie}} = \frac{D_0}{kT} |e| Z^* \rho \exp \left( -\frac{Q}{kT} \right)
\]

Where \( Z^* \) is an effective charge (\( Z^* = 47 \))\(^{1} \) \( e \) the electron charge, \( k \) Boltzmann’s constant, \( \rho \) the resistivity. Hence, in terms of the above \( D_0 \) and the activation energy \( Q \) of lead in copper, \( v_{\text{ie}} \) in eq. (3) is about \( 10^3 \, \mu\text{m}\cdot\text{s}^{-1} \) and it is two orders of magnitude less than that in present work. Therefore, the special ECP effect on the pre-exponential factor \( D_0 \) and the activation energy \( Q \) should be reconsidered. According to the relationship between \( D_0 \) and \( Q \) proposed by Zener and Wert,\(^{20}\) if only integrating the positive current density over ECP remaining time, the activation energy \( Q \) could be approximately evaluated as 1.17 eV for the case of \( v_{\text{ie}} = 10^3 \, \mu\text{m}\cdot\text{s}^{-1} \), which is much lower than the value of 1.89 eV given under the thermal diffusion.\(^{17}\) In fact, Horvath et al. have found that the self-diffusion coefficient in nanocrystalline Cu about 10 nm is as three orders of
magnitude large as coarse-grained Cu, while its diffusion activation energy is comparable with that in surface of Cu. Recently, Zhang et al. have observed that in the coarse-grained Cu-Zn alloy subjected to the ECP treatment, the nanophase about 11 nm was formed. Hence, the transfer of coarse lead inclusions into grain boundaries or defects in dispersed small particles is ascribed to the directional electromigration and also the isotropic diffusion of lead. As a result, in the sample with lead inclusions treated under a current density higher than critical value, the local temperature along grain boundaries and defects is much higher, and the sample is melted and broken (Fig. 2(d)).

5. Conclusion

In summary, the coarse and randomly distributed inclusions disappear at a critical current density and transfer into grain boundaries or defects, forming many dispersed small particles by the application of ECP treatment. The fast atom diffusion caused by ECP can be ascribed to not only the dramatically reduction of the diffusion activation energy of lead in Cu-Zn alloy, but also the considerable acceleration of the lead diffusion in it at a critical current density. Therefore, the ECP treatment may be a new approach to refine the inclusions of materials in future.

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REFERENCES